



## FGPF30N45T

### 450V, 30A PDP Trench IGBT

#### Features

- High Current Capability
- Low saturation voltage:  $V_{CE(sat)} = 1.55V$  @  $I_C = 30A$
- High input impedance
- Fast switching
- RoHS compliant

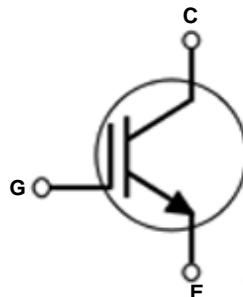
#### Applications

- PDP System



#### General Description

Using Novel Trench IGBT Technology, Fairchild's new series of trench IGBTs offer the optimum performance for PDP applications where low conduction and switching losses are essential.



#### Absolute Maximum Ratings

| Symbol      | Description   | Ratings     | Units      |
|-------------|---|-------------|------------|
| $V_{CES}$   | Collector to Emitter Voltage  | 450         | V          |
| $V_{GES}$   | Gate to Emitter Voltage   | $\pm 30$    | V          |
| $I_{CM(1)}$ | Pulsed Collector Current @ $T_C = 25^\circ C$                           | 120         | A          |
| $P_D$       | Maximum Power Dissipation @ $T_C = 25^\circ C$                          | 50.4        | W          |
|             | Maximum Power Dissipation @ $T_C = 100^\circ C$                         | 20.1        | W          |
| $T_J$       | Operating Junction Temperature  | -55 to +150 | $^\circ C$ |
| $T_{stg}$   | Storage Temperature Range   | -55 to +150 | $^\circ C$ |
| $T_L$       | Maximum Lead Temp. for soldering Purposes, 1/8" from case for 5 seconds | 300         | $^\circ C$ |

##### Notes:

1: Repetitive test , Pulse width=100usec , Duty=0.1

\*  $I_{C\_pulse}$  limited by max  $T_J$

#### Thermal Characteristics

| Symbol                | Parameter                               | Typ. | Max. | Units        |
|-----------------------|---|------|------|--------------|
| $R_{\theta JC}(IGBT)$ | Thermal Resistance, Junction to Case    | -    | 2.48 | $^\circ C/W$ |
| $R_{\theta JA}$       | Thermal Resistance, Junction to Ambient | -    | 62.5 | $^\circ C/W$ |

## Package Marking and Ordering Information

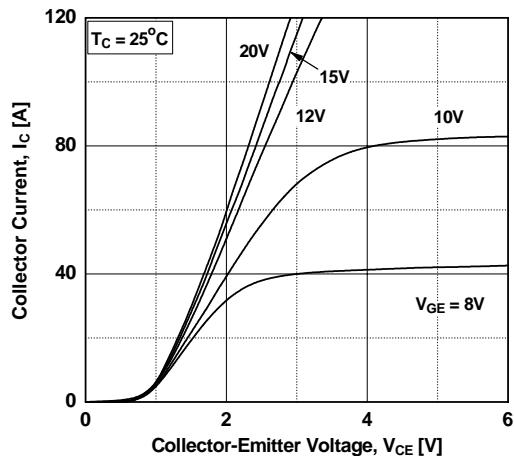
| Device Marking | Device       | Package | Packaging Type | Qty per Tube | Max Qty per Box |
|----------------|--------------|---------|----------------|--------------|-----------------|
| FGPF30N45T     | FGFP30N45TTU | TO-220F | Rail / Tube    | 50ea         | -               |

## Electrical Characteristics of the IGBT $T_C = 25^\circ\text{C}$ unless otherwise noted

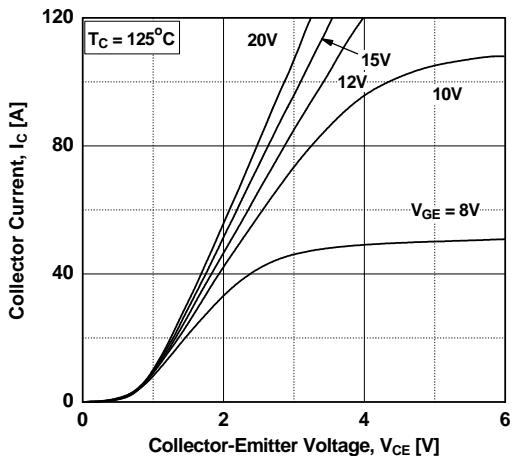
| Symbol   | Parameter                                    | Test Conditions   | Min. | Typ. | Max.      | Units                     |
|--|--|---|------|------|-----------|---------------------------|
| <b>Off Characteristics</b>                         |  |   |      |      |           |                           |
| $\text{BV}_{\text{CES}}$                           | Collector to Emitter Breakdown Voltage       | $V_{\text{GE}} = 0\text{V}, I_{\text{C}} = 250\mu\text{A}$  | 450  | -    | -         | V                         |
| $\frac{\Delta \text{BV}_{\text{CES}}}{\Delta T_J}$ | Temperature Coefficient of Breakdown Voltage | $V_{\text{GE}} = 0\text{V}, I_{\text{C}} = 250\mu\text{A}$  | -    | 0.5  | -         | $\text{V}/^\circ\text{C}$ |
| $I_{\text{CES}}$                                   | Collector Cut-Off Current                    | $V_{\text{CE}} = V_{\text{CES}}, V_{\text{GE}} = 0\text{V}$   | -    | -    | 100       | $\mu\text{A}$             |
| $I_{\text{GES}}$                                   | G-E Leakage Current                          | $V_{\text{GE}} = V_{\text{GES}}, V_{\text{CE}} = 0\text{V}$   | -    | -    | $\pm 400$ | nA                        |
| <b>On Characteristics</b>                          |  |   |      |      |           |                           |
| $V_{\text{GE}(\text{th})}$                         | G-E Threshold Voltage                        | $I_{\text{C}} = 250\mu\text{A}, V_{\text{CE}} = V_{\text{GE}}$  | 3.0  | 4.5  | 5.5       | V                         |
| $V_{\text{CE}(\text{sat})}$                        | Collector to Emitter Saturation Voltage      | $I_{\text{C}} = 20\text{A}, V_{\text{GE}} = 15\text{V}$   | -    | 1.35 | 1.6       |                           |
|  |  | $I_{\text{C}} = 30\text{A}, V_{\text{GE}} = 15\text{V}$   | -    | 1.55 | -         | V                         |
|  |  | $I_{\text{C}} = 30\text{A}, V_{\text{GE}} = 15\text{V}, T_C = 125^\circ\text{C}$  | -    | 1.53 | -         | V                         |
| <b>Dynamic Characteristics</b>                     |  |   |      |      |           |                           |
| $C_{\text{ies}}$                                   | Input Capacitance                            | $V_{\text{CE}} = 30\text{V}, V_{\text{GE}} = 0\text{V}, f = 1\text{MHz}$  | -    | 1610 | -         | pF                        |
| $C_{\text{oes}}$                                   | Output Capacitance                           |   | -    | 88   | -         | pF                        |
| $C_{\text{res}}$                                   | Reverse Transfer Capacitance                 |   | -    | 68   | -         | pF                        |
| <b>Switching Characteristics</b>                   |  |   |      |      |           |                           |
| $t_{\text{d(on)}}$                                 | Turn-On Delay Time                           | $V_{\text{CC}} = 200\text{V}, I_{\text{C}} = 30\text{A}, R_G = 15\Omega, V_{\text{GE}} = 15\text{V}, \text{Resistive Load, } T_C = 25^\circ\text{C}$  | -    | 19   | -         | ns                        |
| $t_r$  | Rise Time                                    |   | -    | 57   | -         | ns                        |
| $t_{\text{d(off)}}$                                | Turn-Off Delay Time                          |   | -    | 119  | -         | ns                        |
| $t_f$  | Fall Time                                    |   | -    | 220  | 330       | ns                        |
| $t_{\text{d(on)}}$                                 | Turn-On Delay Time                           | $V_{\text{CC}} = 200\text{V}, I_{\text{C}} = 30\text{A}, R_G = 15\Omega, V_{\text{GE}} = 15\text{V}, \text{Resistive Load, } T_C = 125^\circ\text{C}$ | -    | 20   | -         | ns                        |
| $t_r$  | Rise Time                                    |   | -    | 60   | -         | ns                        |
| $t_{\text{d(off)}}$                                | Turn-Off Delay Time                          |   | -    | 122  | -         | ns                        |
| $t_f$  | Fall Time                                    |   | -    | 265  | -         | ns                        |
| $Q_g$  | Total Gate Charge                            | $V_{\text{CE}} = 200\text{V}, I_{\text{C}} = 30\text{A}, V_{\text{GE}} = 15\text{V}$  | -    | 73   | -         | nC                        |
| $Q_{\text{ge}}$                                    | Gate to Emitter Charge                       |   | -    | 11   | -         | nC                        |
| $Q_{\text{gc}}$                                    | Gate to Collector Charge                     |   | -    | 33   | -         | nC                        |

## Typical Performance Characteristics

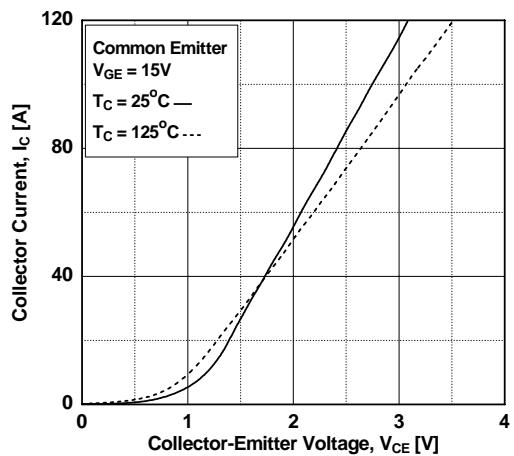
**Figure 1. Typical Output Characteristics**



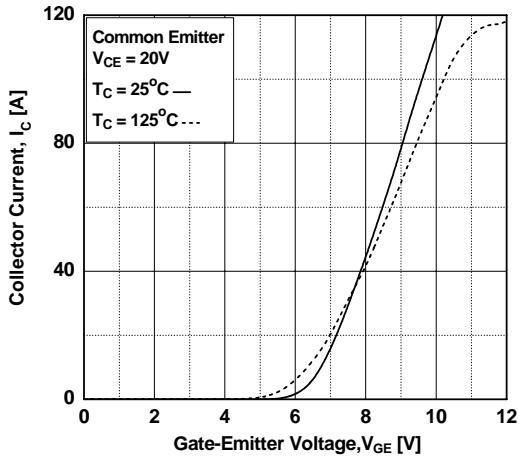
**Figure 2. Typical Output Characteristics**



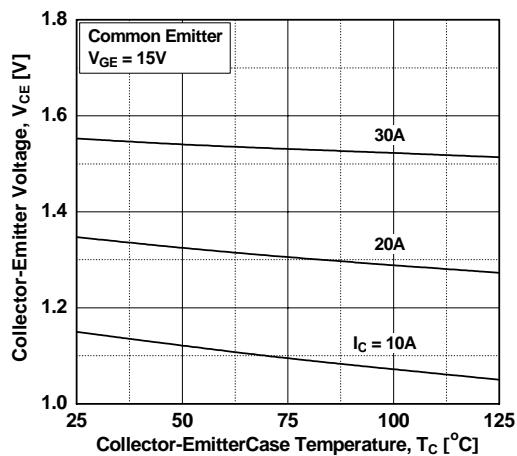
**Figure 3. Typical Saturation Voltage Characteristics**



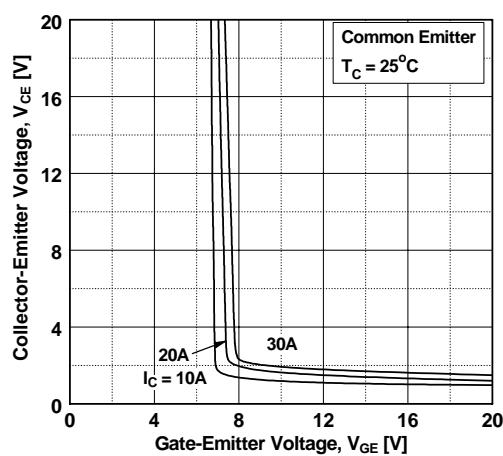
**Figure 4. Transfer Characteristics**



**Figure 5. Saturation Voltage vs. Case Temperature at Variant Current Level**



**Figure 6. Saturation Voltage vs.  $V_{GE}$**



## Typical Performance Characteristics

Figure 7. Saturation Voltage vs.  $V_{GE}$

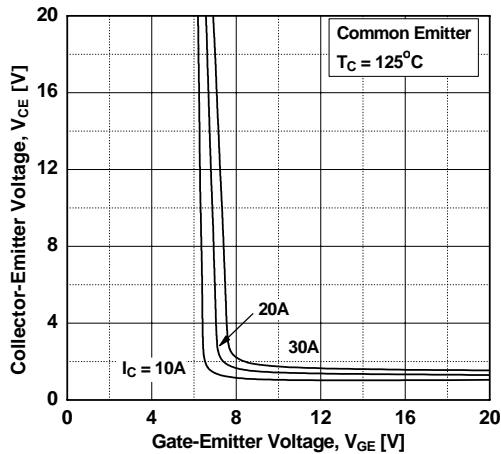


Figure 8. Capacitance Characteristics

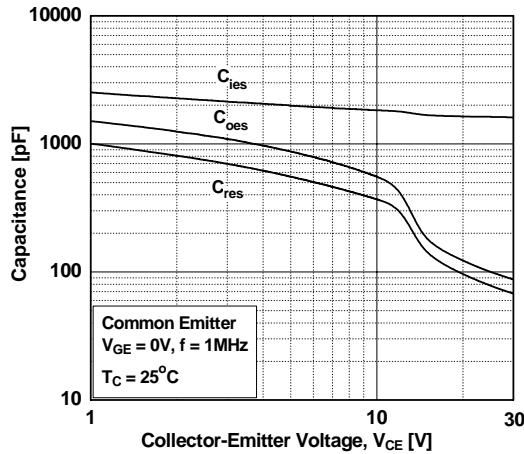


Figure 9. Gate charge Characteristics

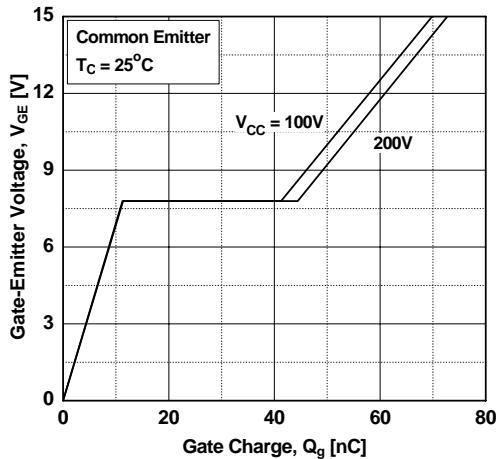


Figure 10. SOA Characteristics

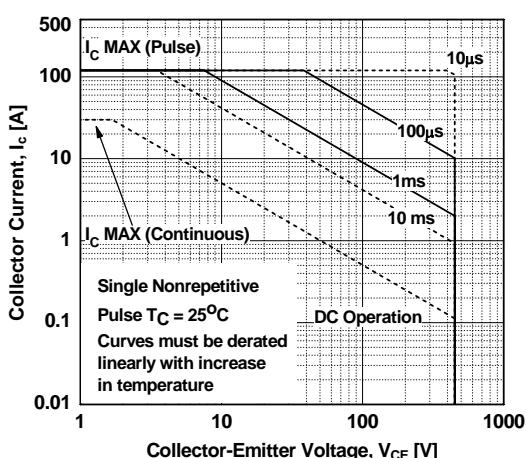


Figure 11. Turn-on Characteristics vs. Gate Resistance

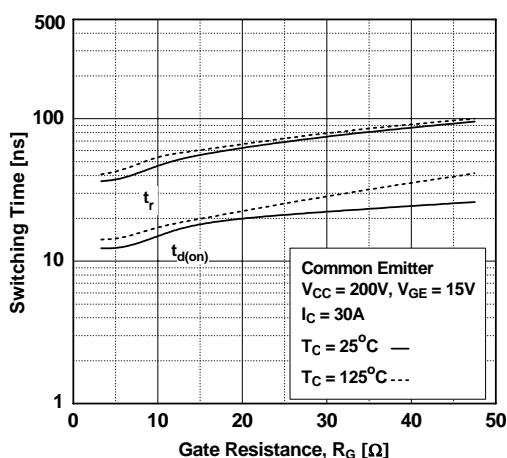
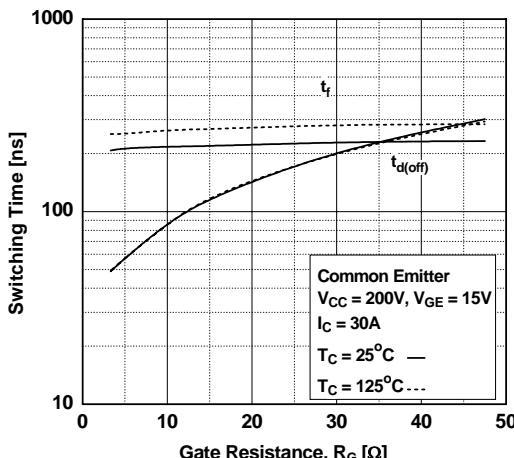
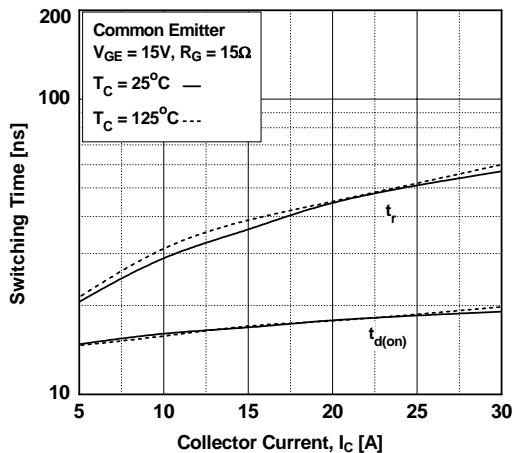


Figure 12. Turn-off Characteristics vs. Gate Resistance

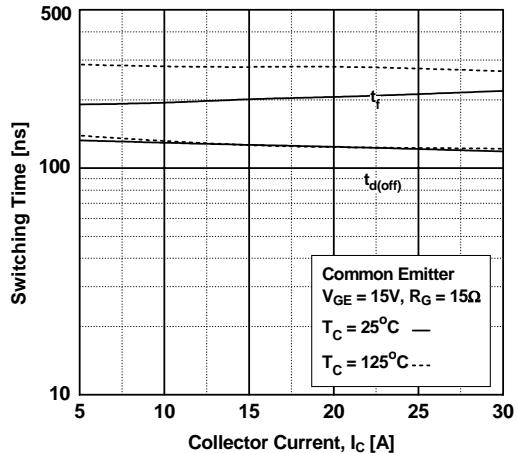


## Typical Performance Characteristics

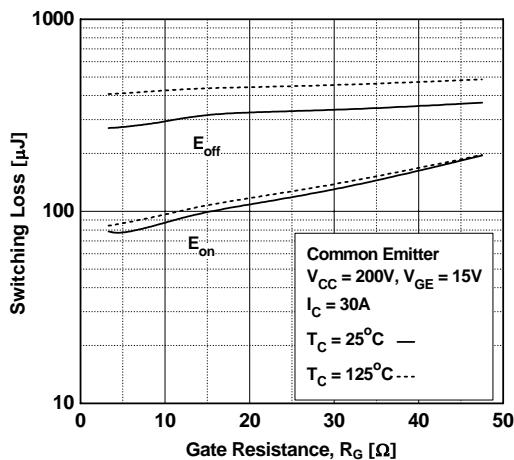
**Figure 13. Turn-on Characteristics vs. Collector Current**



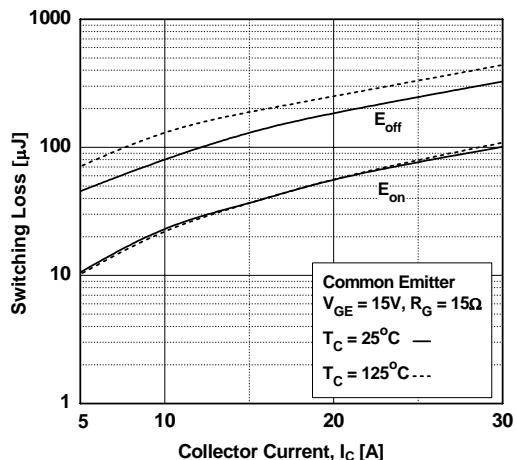
**Figure 14. Turn-off Characteristics vs. Collector Current**



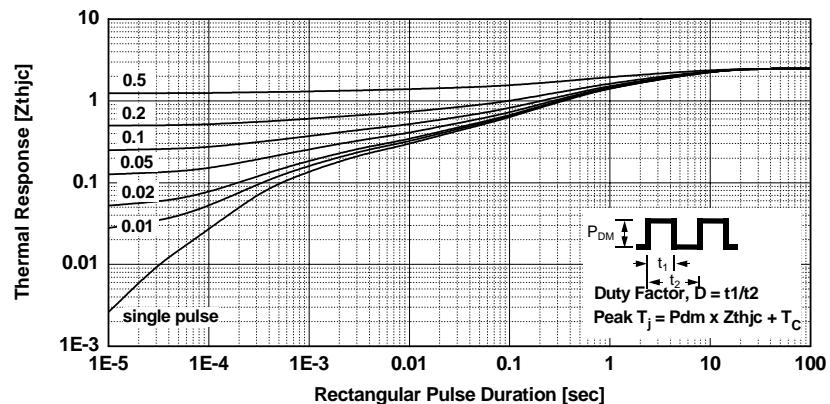
**Figure 15. Switching Loss vs. Gate Resistance**



**Figure 16. Switching Loss vs. Gate Resistance**

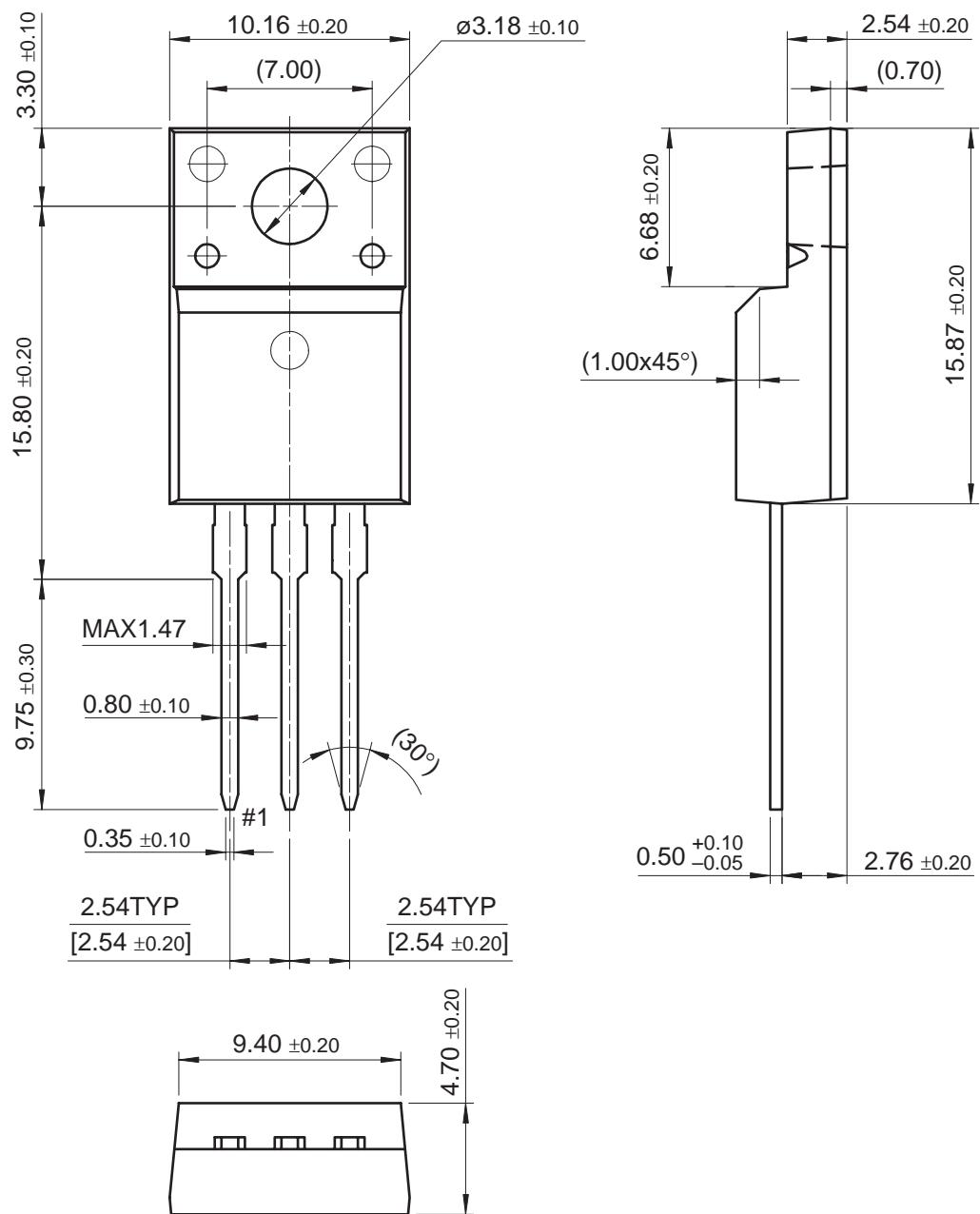


**Figure 17. Transient Thermal Impedance of IGBT**



## Mechanical Dimensions

TO-220F



Dimensions in Millimeters



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| FRFET <sup>®</sup>                   | Power220 <sup>®</sup>   | SuperSOT™-6                |                                  |
| Global Power Resource <sup>SM</sup>  |                         |                            |                                  |

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Rev. J31